AUTOMOTIVE

RoHS

COMPLIANT

HALOGEN

FREE



## Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



Cathode O Anode

### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	5.0 A			
$V_{RRM}$	60 V			
I <sub>FSM</sub>	100 A			
V <sub>F</sub> at I <sub>F</sub> = 5.0 A (125 °C)	0.48 V			
T <sub>J</sub> max.	150 °C			
Package	SlimSMA (DO-221AC)			
Circuit configuration	Single			

#### **FEATURES**

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **TYPICAL APPLICATIONS**

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

### **MECHANICAL DATA**

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)			
PARAMETER	SYMBOL	VSSAF5L63	UNIT
Device marking code		5L63	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	60	V
Maximum DC forward current	I <sub>F(AV)</sub> <sup>(1)</sup>	2.6	^
Maximum DC forward current	I <sub>F(AV)</sub> (2)	5.0	A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	100	А
Operating junction temperature range	T <sub>J</sub> <sup>(3)</sup>	-40 to +150	°C
Storage temperature range	T <sub>STG</sub>	-55 to +150	°C

### Notes

- (1) Free air, mounted on recommended copper pad area
- (2) Mounted on 30 mm x 30 mm pad area
- $^{(3)}$  The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 2.5 A	$I_F = 2.5 \text{ A}$ $I_F = 5.0 \text{ A}$ $T_J = 25 \text{ °C}$	V <sub>F</sub> <sup>(1)</sup>	0.46	-	V
	I <sub>F</sub> = 5.0 A			0.52	0.6	
	I <sub>F</sub> = 2.5 A	- T <sub>J</sub> = 125 °C		0.37	-	
	I <sub>F</sub> = 5.0 A			0.48	0.55	
Reverse current	V <sub>R</sub> = 60 V	T <sub>J</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	0.08	- mA
	v <sub>R</sub> = 60 v	T <sub>J</sub> = 125 °C		4	9	
Typical junction capacitance	4.0 V, 1 MHz		CJ	780	-	pF

#### **Notes**

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified)				
PARAMETER SYMBOL VSSAF5L63 UNI				
Typical thormal registance	R <sub>0</sub> JA (1)(2)	115	°C/W	
Typical thermal resistance	R <sub>θJM</sub> (3)	12		

#### **Notes**

 $^{(3)}$  Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient

 $^{(4)}$  The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/DT_J < 1/R_{\theta JA}$ 

 $^{(5)}$  Mounted on 30 mm x 30 mm pad area,  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
VSSAF5L63-M3/H	0.032	Н	3500	7" diameter plastic tape and reel	
VSSAF5L63-M3/I	0.032	I	14 000	13" diameter plastic tape and reel	
VSSAF5L63HM3/H (1)	0.032	Н	3500	7" diameter plastic tape and reel	
VSSAF5L63HM3/I (1)	0.032	I	14 000	13" diameter plastic tape and reel	

## Note

(1) AEC-Q101 qualified

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## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

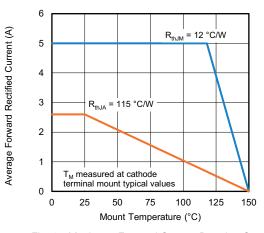


Fig. 1 - Maximum Forward Current Derating Curve

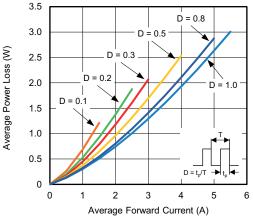


Fig. 2 - Forward Power Loss Characteristics

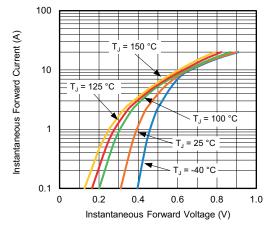


Fig. 3 - Typical Instantaneous Forward Characteristics

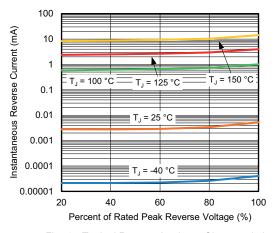


Fig. 4 - Typical Reverse Leakage Characteristics

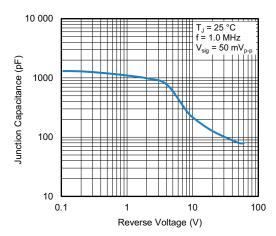


Fig. 5 - Typical Junction Capacitance

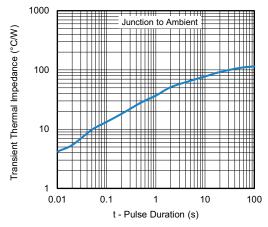


Fig. 6 - Typical Transient Thermal Impedance

0.047 (1.20)

MIN.

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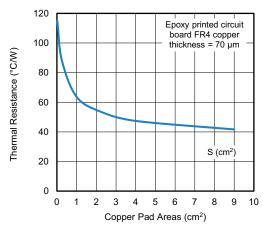


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Area

### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

### SlimSMA (DO-221AC) Cathode Band 0.106 (2.70) 0.057 (1.45) 0.098 (2.50) 0.049 (1.25) 0.171 (4.35) 0.047 (1.20) Typ.: 0.019 (0.48) 0.163 (4.15) 0.030 (0.75) 0.211 (5.35) 0.199 (5.05) **Mounting Pad Layout** 0.039 (1.00) 0.035 (0.90) 0.060 (1.52) 0.012 (0.30) MIN. 0.006 (0.15)

0.047 (1.20)

MIN.

0.123 (3.12) MAX.

0.217 (5.52) REF.



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